## $\operatorname{NEL}$ crystal clock oscillators

## THERMAL ANALYSIS **SJ/HJ-XXXX Series**

Thermal measurements were made on an HJ-100 oscillator. IC size was 0.050" X 0.050". Areas measured were the top of the substrate, bottom of the package, and the IC. The results are as follows:

Ambient Air =  $24.2^{\circ}$ C Package Temperature =  $26.2^{\circ}$ C Substrate Temperature =  $26.7^{\circ}$ C IC Temperature =  $27.2^{\circ}$ C Power Dissipation = 76.6 mwatts

Based on these measurements, the following thermal resistances were calculated:

Package to Air  $\emptyset = 26.11^{\circ}$ C/watt IC to Substrate  $\emptyset = 6.53^{\circ}$ C/watt Package to Substrate  $\emptyset = 6.53^{\circ}$ C/watt IC to Package  $\emptyset = 13.05^{\circ}$ C/watt IC to Air  $\emptyset = 39.16^{\circ}$ C/watt

Air is defined to be free uncontrolled air.